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				Application Number	Not yet assigned 10/31/86
				Filing Date	Herewith
				First Named Inventor	COHEN, Eytan
				Group Art Unit	Not yet assigned
				Examiner Name	Not yet assigned
				Attorney Docket Number	P-6096-US1
Sheet	1	of	1		

[illegible][illegible]

Examiner Signature	<i>[Signature]</i>	Date Considered	11/18/00
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